OpenPICs WP3



Agenda - Part I (start 14:00)

- 1. Last meeting's action points
- 2. Progress and issues to be raised per partner
 - a. TU/e
 - b. Smart Photonics
 - c. Bright Photonics
 - d. Effect Photonics
 - e. Technobis
- 3. Summary





Action Points



Nr.	Description	Responsible
1.	Planning WP3	
	Revised and agreed on WP3 plan and its relation to MPW runs	
2.	Milestones and Reports	By June, 1
	Complete due milestones/reports, complete list of criteria, complete 1 page	
	summary	
3.	BB Test cell – wafer prober	Weiming,
	Define measurement procedures for test structures and align that with wafer prober setup from Smart.	Erik, Rui



Chips WP3

chips

MPW parallel chips MPW commercial (x) = reserve space for design



		SP19	SP20	SP21	SP22	SP23	SP24	SP25	SP26	SP27	SP28	SP29	SP30
		Dec-16	Mar-17	Jun-17		Dec-17					Mar-19	Jun-19	
Modulator		2 00 20	1st		оор =:			2nd	оор =	2 00 20	3rd	00 =0	
	Plating chip + parameter extraction	X		X		Х		X					
	Modulator chip (Effect+SI+plating)			X	Х	x	Х	→WP2					
	Al-MQW parallel wafer							X	X	Х	X	→WP2	
	CL-TWE chip										X	Х	X
RF Line	Conventional design				X	X	X			X	Х	X	
	2 nd level metal RF line				X	X	X	Х	X				
BB test cell	Wafer level test		X	Х	Х	X	X	Х	Х	X	X	X	X
	Die level test		X	Х	Х	X	Х	Х	Х	X	X	X	X
	Composite BBs				X								
Prec. Filter	(ring, AWG, MZI)			?			?			?			
Low LW LD													
	DBR laser			X (subcell)									
	Triplex Hybrid				X								
	High Q cavity laser									?			
Demo	both chips								Х				



List of Milestones

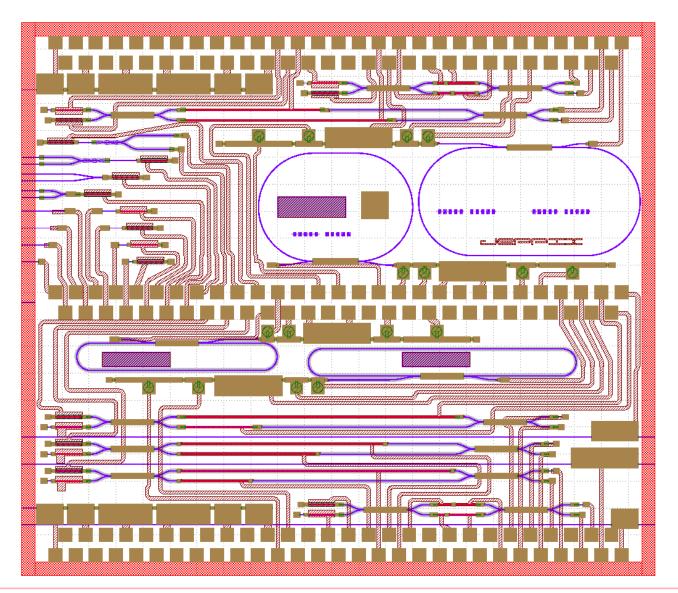


Item ID	Title	Туре	Partner	Responsible	due time	1 page summary	full item
WP3.1.M0	Technology and Design Concept	Milestone	TU/e	Weiming	Dec-16	ready	ready
WP3.1.R0	Analysis and Design	Report	TU/e	Weiming	Jun-17	ready	not ready
WP3.1.M1	Mask Design Tape-out I	Milestone	TU/e	Weiming	Jun-17	ready	not ready
WP3.2.M2	Definition of composite BB FoM	Milestone	TU/e	Weiming	Mar-17	ready	ready
WP3.2.R0	Definition of measurement procedures	Report	TU/e	Weiming	Jun-17	ready	not ready
WP3.3.R0	Design of Standard MPW BB test cell	Report	SMART	Weiming	Mar-17	ready	ready
WP3.2.M0	State of the PDK	Milestone	SMART	Rui	Dec-16	ready	ready
WP3.2.M1	Definition of basic BB figure of merits	Milestone	SMART	Rui	Mar-17	ready	ready
WP3.4.DF.R0	Design Flow document	Report	Phoenix	Marcel	Mar-17	not ready	not ready
WP3.4.DF.R1	Improvement points	Report	Phoenix	Marcel	Apr-17	not ready	not ready
WP3.4.PDA.M0	Development of PDAflow template	Milestone	Phoenix	Marcel	Mar-17	not ready	not ready
WP3.4.PDA.M1	Implementation of first building block	Milestone	Phoenix	Marcel	Apr-17	not ready	not ready
WP3.4.PDA.R0	Full documentation of template	Report	Phoenix	Marcel	Mar-17	not ready	not ready
WP3.4.DRC.R0	DRC requirement report	Report	Phoenix	Marcel	May-17	not ready	not ready
WP3.1.M0	Technology and Design Concept	Milestone	Bright	Ronald	Dec-16	not ready	not ready
WP3.1.R0	Analysis and Design	Report	Bright	Ronald	Jun-17	not ready	not ready
WP3.1.M1	Mask Design Tape-out I	Milestone	Bright	Ronald	Jun-17	not ready	not ready
WP3.4.EF.R0	Exectution Flow document	Report	Bright	Ronald	May-17	not ready	not ready
WP3.5.R0	400G Transmitter concept	Report	EFFECT	Saeed	Mar-17	ready	not ready
WP3.5.R1	Fiber sensing chip concept	Report	Technobis	Pim	Mar-17	ready	not ready



Documentation of Meas. Proc.





- Standardized naming convention
- Compatibility for packaging
- Compatibility for automated reading (markup language)

Functional structure oriented description



Structure agnostic description





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Summer Schedule





OpenPICs WP3



Agenda - Part II (start 15:00)

- 1. Last meeting's action points
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 - d. Phoenix
- 3. Summary





Database discussion summary



Common interfaces for transfer of data sets

■ TU/e: need for efficient storage and correlation of measurement data

Smart: MESS system adoption, ownership and access rights

Bright: access to data for more efficient design, collect list of queries

Phoenix: elaborated on relations in a measurement database



Measurement Template



Environment Chip under Test **Device under Test** Measurement Setup Raw Data

Temperature Operator Time stamp Run ID Designer Wafer ID Simulation data etc Die ID Additional info Device structure Designer Simulation data etc Measurement type Input output range Additional info Setup ID State of equipment Timestamp Parts used Calibration ID Calibraiton data Format Storage







Summer Schedule



